

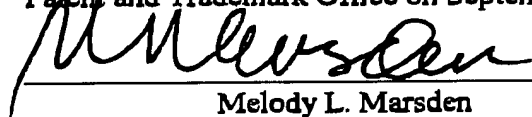
OGOSHI46USA

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. : 10/567,729  
Applicant : Kojima et al.  
Filed: : February 1, 2006  
Art Unit : 2811  
Customer No. : 00270  
Title : SILICON CARBIDE EPITAXIAL WAFER, METHOD FOR  
PRODUCING SUCH WAFER, AND SEMICONDUCTOR  
DEVICE FORMED ON SUCH WAFER

Certificate of Transmission under 37 CFR1.8

I hereby certify that this correspondence is  
being facsimile transmitted to the United States  
Patent and Trademark Office on September 5, 2006.

  
Melody L. Marsden

Commissioner for Patents  
P.O. Box 1450  
Alexandria VA 22313-1450

REQUEST FOR CORRECTION OF FILING RECEIPT


Sir:

Enclosed is a copy of the Filing Receipt received in the above-identified application.

Please add the following to the Foreign Applications: JAPAN 2003-295413 08/19/2003. A copy of the Declaration and Power of Attorney is also attached.

Applicant respectfully requests that the official filing receipt for this application be corrected to amend the Foreign Applications to read: JAPAN 2003-295413 08/19/2003.

Respectfully submitted,  
HOWSON AND HOWSON  
Attorneys for Applicant

By   
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## UNITED STATES PATENT AND TRADEMARK OFFICE

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| APPL NO.   | FILING OR 371<br>(c) DATE | ART UNIT | FIL FEE REC'D | ATTY. DOCKET NO | DRAWINGS | TOT CLMS | IND CLMS |
|------------|---------------------------|----------|---------------|-----------------|----------|----------|----------|
| 10/567,729 | 02/01/2006                | 2811     | 900           | OGOSH46USA      | 3        | 20       | 3        |

CONFIRMATION NO. 7682

## FILING RECEIPT



\*OC000000020164089\*

00270  
 HOWSON AND HOWSON  
 SUITE 210  
 501 OFFICE CENTER DRIVE  
 FT WASHINGTON, PA 19034

Date Mailed: 08/24/2006

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

## Applicant(s)

Kazutoshi Kojima, Ibaraki, JAPAN;  
 Satoshi Kuroda, Ibaraki, JAPAN;  
 Hajime Okumura, Ibaraki, JAPAN;

Power of Attorney: The patent practitioners associated with Customer Number 00270.

## Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP04/11894 08/19/2004

Foreign Applications JAPAN 2003-295413 08/19/2003

If Required, Foreign Filing License Granted: 08/23/2006

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is **US10/567,729**

Projected Publication Date: 11/30/2006

Non-Publication Request: No

Early Publication Request: No

AUG 3 -

Title

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**DECLARATION AND POWER OF ATTORNEY  
FOR PATENT APPLICATION**

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name, Kazutoshi Kojima, Satoshi Kuroda, and Hajime Okumura. I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled "SILICON CARBIDE EPITAXIAL WAFER, METHOD FOR PRODUCING SUCH WAFER, AND SEMICONDUCTOR DEVICE FORMED ON SUCH WAFER", the specification of which

(Check one) ☐ is attached hereto

☐ was filed on \_\_\_\_\_ as  
Application Serial No. \_\_\_\_\_  
and was amended on \_\_\_\_\_

☒ was described and claimed in PCT International  
Application No. **PCT/JP2004/011894** filed on  
**August 19, 2004.**

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, Section 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

|                    |              |                        | Priority<br>Claimed |    |
|--------------------|--------------|------------------------|---------------------|----|
|                    |              |                        | Yes                 | No |
| <u>2003-295413</u> | <u>Japan</u> | <u>19 August 2003</u>  | <u>X</u>            |    |
| (Number)           | (Country)    | (Day/Month/Year Filed) |                     |    |

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I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

| (Application Serial No.) | (Filing Date)<br>(patented,<br>pending,<br>abandoned) | (Status) |
|--------------------------|---|----------|
|--------------------------|---|----------|

I hereby appoint the following individuals (of Customer No. 00270) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith: STANLEY B. KITA, Registration No. 24,561; GEORGE A. SMITH, JR., Registration No. 24,442; MARY E. BAK, Registration No. 31,215; CATHY A. KODROFF, Registration Number 33,980; WILLIAM BAK, Registration No. 37,277; TRACY PALOVICH, Registration Number 47,840; and ROBERT DUMINIAK, Registration Number 51,636.

Address all telephone calls to William Bak at telephone no. (215) 540-9216. Address all correspondence to HOWSON AND HOWSON, Spring House Corporate Center, P. O. Box 457, Spring House, Pennsylvania 19477.

I hereby declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of joint inventor: Kazutoshi Kojima

Inventor's signature 児島 一孝 25 Jan 2006  
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Full name of joint inventor: Hajime Okumura

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ADDED PAGE TO COMBINED DECLARATION AND POWER OF ATTORNEY  
FOR AUTHORIZATION OF ATTORNEY(S) TO ACCEPT AND FOLLOW  
INSTRUCTIONS FROM REPRESENTATIVE

The undersigned to this declaration and power of attorney hereby authorizes the U.S. attorney(s) named herein to accept and follow instructions from:

OGOSHI International Patent Office  
Toranomom 9 Mori Bldg. 3F  
2-2 Atago 1-Chome  
Minato-ku, Tokyo 105-0002  
Japan

as to any actions to be taken in the Patent and Trademark Office regarding this application without direct communication between the U.S. attorney(s) and the undersigned. In the event of a change in the person(s) from whom instructions may be taken, the U.S. attorney(s) will be so notified by the undersigned.